

# **Double-Sided Exposure Machine for Semiconductor Market Forecasts to 2034 – Global Analysis By Type (Semi Automatic and Fully Automatic), Technology (Photolithography and E-beam Lithography), Application and By Geography**

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## **Abstracts**

According to Statistics MRC, the Global Double-Sided Exposure Machine (Semiconductor) Market is accounted for \$388.0 million in 2026 and is expected to reach \$586.6 million by 2034 growing at a CAGR of 5.3% during the forecast period. A specialized tool used in the production of semiconductors is known as double-sided exposure machine for semiconductors. It employs advanced optics and light sources to project intricate circuit patterns onto the photoresist-coated surfaces of the wafer. Its precision and efficiency are essential for maintaining the high standards required in semiconductor manufacturing, where nanoscale features and precise alignment are paramount for the successful production of cutting-edge electronic devices.

According to UMC, it would also be one of the most advanced semiconductor foundries in Singapore and will produce 22 nm and 28 nm chips.

Market Dynamics:

Driver:

Increasing demand for advanced semiconductors

Double-Sided Exposure Machines enable the fabrication of semiconductors that meet the requirements of these emerging technologies, including 5G, edge computing, and electric vehicles. These ongoing technological advancements are implemented in

various industries, including automotive, healthcare, and communications. In addition, they contribute to the production of high-density and high-performance chips needed for these applications, which is boosting market expansion.

#### Restraint:

##### High cost

Manufacturers, especially smaller ones, face financial challenges due to the capital-intensive nature of these advanced systems. Limited competition can contribute to higher prices, as manufacturers may have more control over pricing in the absence of extensive alternatives. In addition, the widespread adoption of ongoing technological advancements may be decreased by the industry's cost sensitivity and requirements, which significantly hamper the market's growth.

#### Opportunity:

##### New technological innovations in 3D ICs

3D three-dimensional integrated circuits (ICs), with vertically stacked semiconductor layers, demand precise and simultaneous exposure on both sides of wafers. Incorporating machine learning and artificial intelligence into exposure machines can contribute to better alignment accuracy, error detection, and correction. Additionally, these technologies aimed at improving overall productivity, meeting the demands of an evolving electronics industry that increasingly relies on 3D ICs for improved performance and miniaturization, thereby driving market's expansion.

#### Threat:

##### Issues associated with intellectual property (IP)

Patent disputes can cause delays in new product development and market launches. The complex technologies involved in these machines make them susceptible to patent disputes and legal challenges. Legal ambiguities affect the market's potential by creating a difficult environment for investors and manufacturers, influencing product pricing, profitability, and potential resistance from regulatory authorities. Furthermore, IP concerns may also decrease industry-player collaboration or acquisitions, which can hinder market expansion.

## Covid-19 Impact

The market for double-sided exposure machines for semiconductors was adversely affected by the COVID-19 pandemic. Manufacturing processes were impacted by lockdowns and restrictions, disruptions to workforce availability, remote work challenges, and health concerns, which contributed to delays and inefficiencies in the development and deployment of advanced machinery. Additionally, travel restrictions made it more difficult to collaborate and install internationally, and economic challenges prompted some companies to delay or cancel expansion projects, which thereby hampered market growth.

The semi automatic segment is expected to be the largest during the forecast period

The semi automatic segment is estimated to hold the largest share. It refers to equipment that combines advanced automation features with manual control including automated features to improve accuracy and exposure process efficiency, providing a certain amount of flexibility and human control. As technology advances, these machines continue to evolve, incorporating technologies to enhance precision, speed, and overall performance with cost-effective solutions for semiconductor manufacturers seeking customizable and adaptable processes which are boosting this segment expansion.

The photolithography segment is expected to have the highest CAGR during the forecast period

The photolithography segment is anticipated to have highest CAGR during the forecast period, due to it deals with devices that are necessary for accurately transferring complex circuit patterns onto semiconductor wafers. Advancements in multiple patterning techniques, such as EUV lithography, high-resolution imaging, and advanced semiconductor devices are essential for a wide range of applications, from telecommunications and electronics to emerging technologies like artificial intelligence and the Internet of Things. In addition, these devices use sophisticated optical methods to simultaneously assure precise alignment and exposure on both sides of the wafer which significantly drive market's growth.

Region with largest share:

Europe commanded the largest market share during the extrapolated period owing to government laws and regulations that affect the production of semiconductors. The

European Union prioritizes research, technology, and innovation, creating an environment that is favorable for advancements in the semiconductor industry. Countries like Germany, the United Kingdom, and the Netherlands are at the forefront of semiconductor technology development. Government programs and collaborations between academic institutions and industry players contribute to the region's leadership in semiconductor innovation and thereby boosting the region's growth.

Region with highest CAGR:

North America is expected to witness highest CAGR over the projection period, owing to modern semiconductor research and ongoing developments in automation, materials, and precision optics. Some of the major key players including Nikon Corporation, ASML Holding NV, Canon Inc. and Shanghai Micro Electronics Equipment (Group) Co., Ltd. are contributing in developing the region's technological excellence. Strong ecosystem of skilled professionals and research facilities, machines, are meeting the evolving needs of the industry which are propelling the market expansion.

Key players in the market

Some of the key players in the Double-Sided Exposure Machine for Semiconductor Market include ORC Manufacturing, Ushio Lighting, Csun, Canon Inc, Orbotech Ltd., Neutronix Quintel, Idonus Sarl, Seimyung Vactron, Adtec Engineering and ASML Holding N.V.

Key Developments:

In November 2023, Neutronix-Quintel, Inc., a leading provider of production photolithography equipment, announced the introduction of the NxQ 8000 CT mask aligner to be used for advanced applications.

In October 2023, Canon, a leader in production inkjet presses, announced a technology preview of the Canon varioPRINT iX1700, a new 170 A4 images per minute, sheetfed inkjet press, at Canon Expo in Yokohama, Japan.

In September 2023, Independent visual content provider, EPA Images, announced a five-year partnership with Canon Europe to renew and update its photography and videography equipment to confront the challenges in a changing world.

Types Covered:

Semi Automatic

Fully Automatic

Technologies Covered:

Photolithography

E-beam Lithography

Applications Covered:

Semiconductor Exposure

Semiconductor Pattern Alignment

Regions Covered:

North America

US

Canada

Mexico

Europe

Germany

UK

Italy

France

Spain

Rest of Europe

Asia Pacific

Japan

China

India

Australia

New Zealand

South Korea

Rest of Asia Pacific

South America

Argentina

Brazil

Chile

Rest of South America

Middle East & Africa

Saudi Arabia

UAE

Qatar

South Africa

## Rest of Middle East & Africa

### What our report offers:

Market share assessments for the regional and country-level segments

Strategic recommendations for the new entrants

Covers Market data for the years 2023, 2024, 2025, 2026, 2027, 2028, 2030, 2032 and 2034

Market Trends (Drivers, Constraints, Opportunities, Threats, Challenges, Investment Opportunities, and recommendations)

Strategic recommendations in key business segments based on the market estimations

Competitive landscaping mapping the key common trends

Company profiling with detailed strategies, financials, and recent developments

Supply chain trends mapping the latest technological advancements

### Free Customization Offerings:

All the customers of this report will be entitled to receive one of the following free customization options:

#### Company Profiling

Comprehensive profiling of additional market players (up to 3)

SWOT Analysis of key players (up to 3)

#### Regional Segmentation

Market estimations, Forecasts and CAGR of any prominent country as per the client's interest (Note: Depends on feasibility check)

### Competitive Benchmarking

Benchmarking of key players based on product portfolio, geographical presence, and strategic alliances

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